



Product data sheet

1. Product profile

1.1 General description

LED driver consisting of resistor-equipped PNP transistor with two diodes on one chip in an SOT457 (SC-74) plastic package.

1.2 Features and benefits

- Stabilized output current of 20 mA
- High current accuracy at supply voltage variation
- Low voltage overhead of 1.4 V
- Qualified according to AEC-Q101
- Reduces component count and board space
- High power dissipation of 750 mW
- Stabilized output current adjustable up to 65 mA when an external resistor is used

1.3 Applications

- Constant current LED driver
- Generic constant current source
- Automotive applications

1.4 Quick reference data

Table 1.Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
l _{out}	stabilized output current	V_{S} = 10 V; V_{out} = 8.6 V	17	20	23	mA
Vs	supply voltage		-	-	40	V



2. Pinning information

Pin S	Symbol	Description	Simplified outline	Graphic symbol
1 G	GND	ground		
2 IC	JUT	output current		
3 IC	JUT	output current	0	
4 V	′S	supply voltage		
5 IC	JUT	output current		
6 R	REXT	external resistor		
				1 2 3 aaa-01010

3. Ordering information

Table 3. Ordering	g informatio	on	
Type number	Package		
	Name	Description	Version
NCR402U	SC-74 (TSOP6)	plastic surface-mounted package; 6 leads	SOT457

4. Marking

Table 4.	Marking codes	
Type num	iber	Marking code
NCR402U		DB

5. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
l _{out}	stabilized output current if external resistor is used		-	65	mA
Vs	supply voltage		-	40	V
V _{out}	output voltage	$V_{\rm S} = 40 \ V$	-	38	V
V _R	reverse voltage		<u>[1]</u> -	0.5	V
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[2] _	475	mW
		$T_{amb} \le 25 \ ^{\circ}C$	[3] _	650	mW
		$T_{amb} \le 25 \ ^{\circ}C$	[4] _	750	mW
		$T_{amb} \le 25 \ ^{\circ}C$	<u>[5]</u> _	1100	mW
Тj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

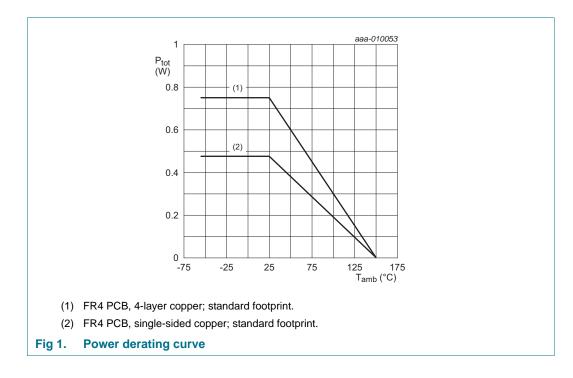
[1] Between all terminals.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB); single-sided copper; tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB; single-sided copper; tin-plated and mounting pad for output 1 cm².

[4] Device mounted on an FR4 PCB; 4-layer copper; tin-plated and standard footprint.

[5] Device mounted on an FR4 PCB; 4-layer copper; tin-plated and mounting pad for output 1 cm².



6. Thermal characteristics

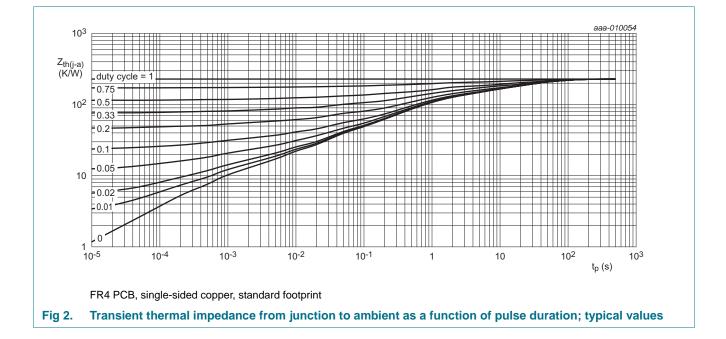
Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)} thermal resistance from junction to ambient	thermal resistance from junction	in free air	<u>[1]</u> -	-	265	K/W
		[2] _	-	190	K/W	
			<u>[3]</u> _	-	165	K/W
			<u>[4]</u> _	-	115	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point	in free air	-	-	50	K/W

[1] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.

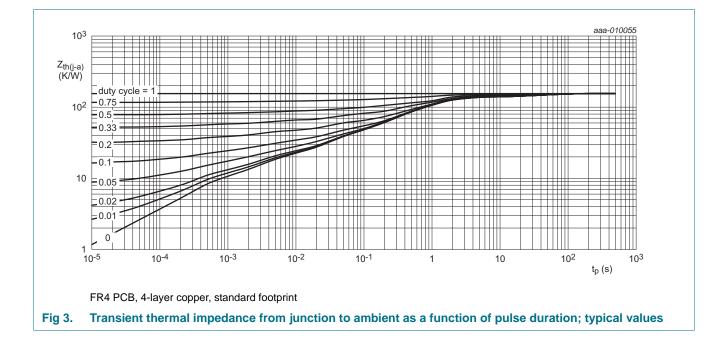
[2] Device mounted on an FR4 PCB; single-sided copper; tin-plated and mounting pad for output 1 cm².

[3] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB; 4-layer copper; tin-plated and mounting pad for output 1 cm².





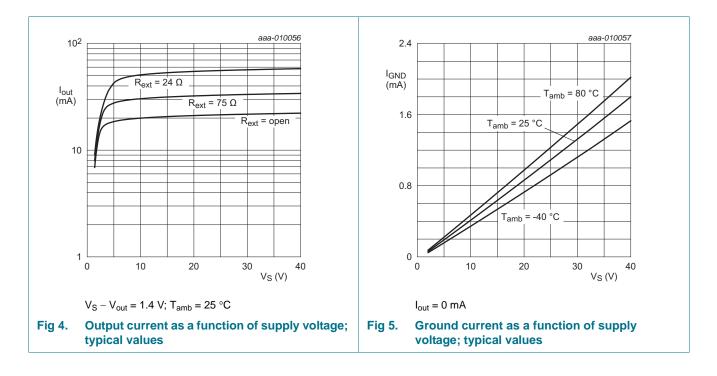


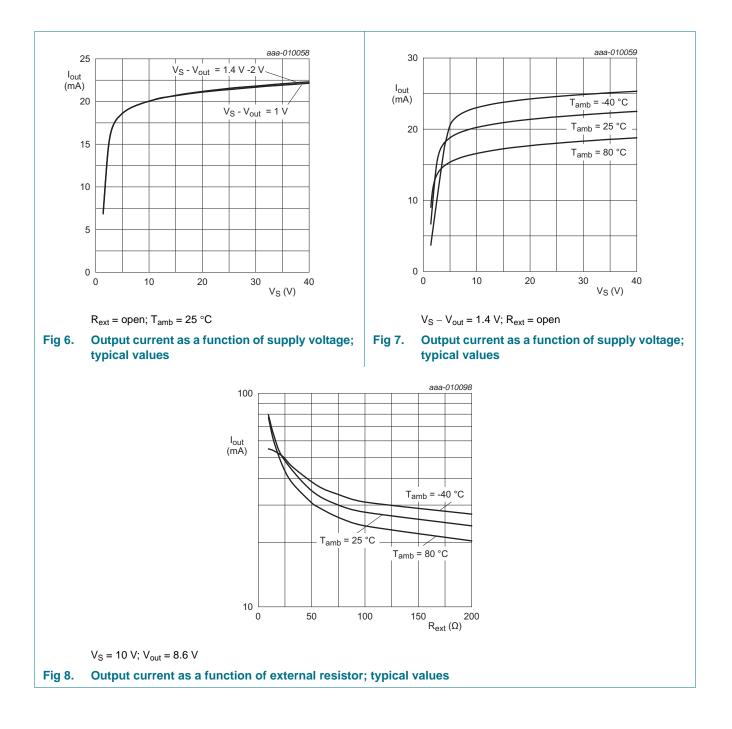
7. Characteristics

Table 7. Characteristics

$T_{amb} = 25 \ ^{\circ}C$; pulse test: $t_P \leq 300 \ \mu$ s; $\delta = 0.02$; unless otherwise sp	ecified.

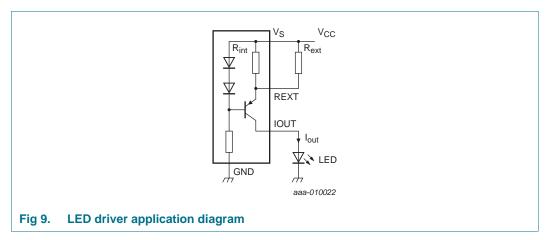
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
l _{out}	stabilized output current	$V_{S} = 10 \text{ V}; V_{out} = 8.6 \text{ V}$	17	20	23	mA
I _{GND}	ground current	$V_{S} = 10 \text{ V}; I_{out} = 0 \text{ A}$	340	420	500	μΑ
R _{int}	internal resistance	I _{Rint} = 20 mA	36	42	52	Ω
V _{Rint}	voltage drop at internal resistance R _{int}	l _{out} = 20 mA	-	0.85	-	V
V _{Smin}	lowest sufficient supply voltage overhead $V_S - V_{out}$	l _{out} > 17 mA	-	1.4	-	V
ΔI_{out} / ($I_{out} \times \Delta T_{amb}$)	stabilized output current change over ambient temperature	$V_{S} = 10 \text{ V}; V_{out} = 8.6 \text{ V}$	-	-0.3	-	%/K
ΔI_{out} / ($I_{out} \times \Delta V_S$)	stabilized output current change over supply voltage	V _S = 10 V; V _S - V _{out} = 1.4 V	-	0.8	-	%/V



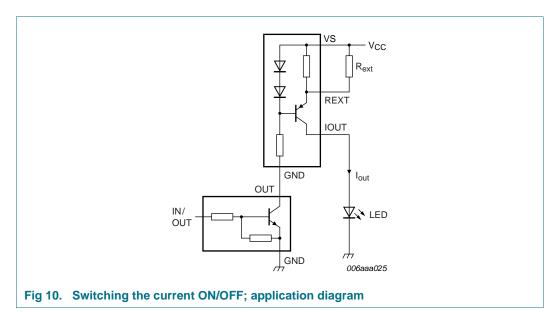


8. Application information

Figure 9 shows a typical application circuit for an LED driver. The constant current ensures a constant LED brightness. The output current can be adjusted between 20 mA and 65 mA by connecting an external resistor R_{ext} . Figure 8 gives a first indication for choosing the external resistor R_{ext} . The output current slightly decreases when the power load at LED driver increases. This effect is due to the self heating of the device and the negative thermal coefficient of the output current.



The output can be switched ON and OFF by connecting a Resistor-Equipped Transistor (RET), e.g. PDTC124XU; see Figure 10.



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9. Test information

9.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

10. Package outline

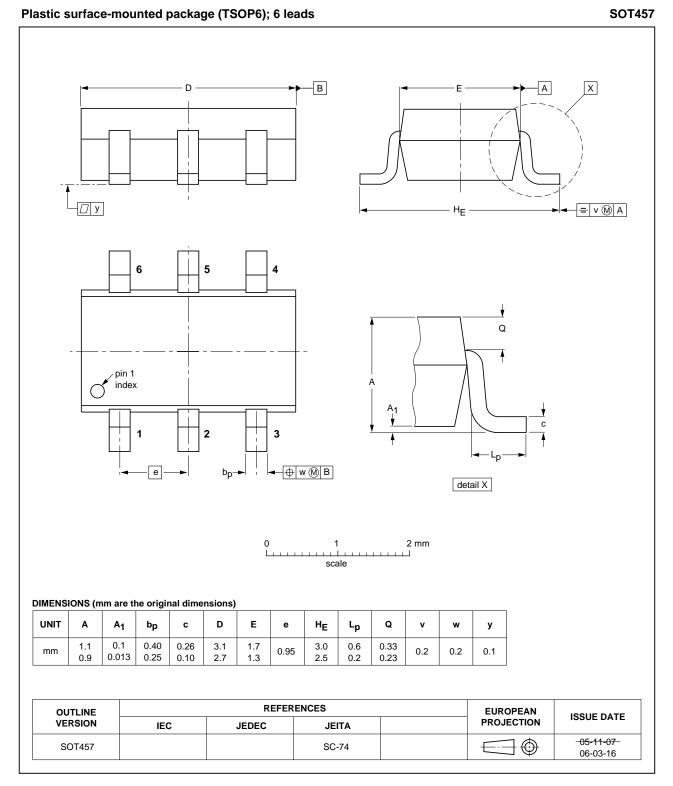
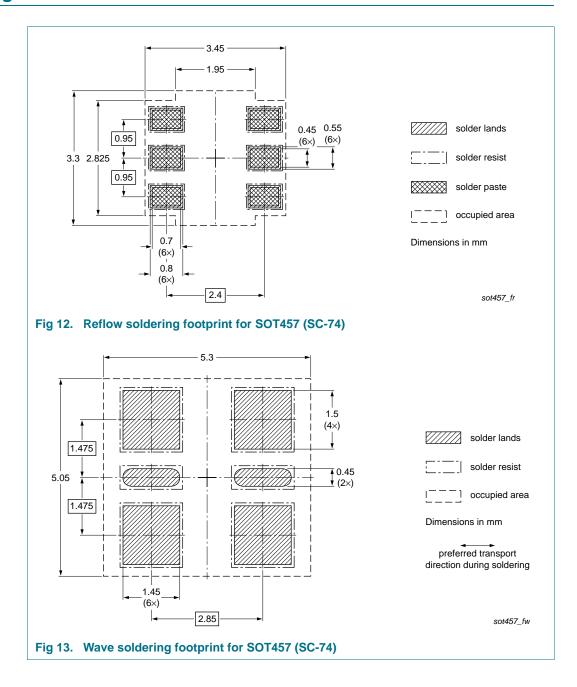


Fig 11. Package outline SOT457 (SC-74)

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11. Soldering



12. Revision history

Table 8. Revision hi	Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
NCR402U v.1	20131210	Product data sheet	-	-		

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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NCR402U 20 mA LED driver

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